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ALPHA-TOP TECHNOLOGY CORP.

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APPROVAL SHEET

| MODEL NO.: | SMD1210-025 | | |
|-----------------|--------------|--|--|
| | | | |
| CUSTOMER: | | | |
| | | | |
| | | | |
| CUSTOMER'S APPF | ROVAL: | | |
| AUTHORIZED SIGN | ATURE/STAMP: | | |
| | | | |
| DATE | | | |

MANUFACTURER:

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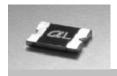
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Submitted by: Chung Cheng Approved by: YC Lin DATE: 11-Apr-13

SEA & LAND ELECTRONIC CORP.



SMD1210-025

Features

- Surface Mount Devices
- Lead free device
- Size 3.2*2.5mm/0.12*0.10 inch
 Surface Mount packaging
- for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 30V and a load to be

protected, including:

■ Computer mother board, Modem.

■ Telecommunication equipments.

Alpha-Top (Sea&Land Alliance)

Performance Specification

| | Model | Marking | V_{max} | I _{max} | I _{hold} | I _{trip} | P_d | | mum Го Trip | Resis | stance |
|---|-------------|---------|-----------|------------------|-------------------|-------------------|-------|---------|----------------|------------|-------------------|
| Н | Wodel | Walking | | | @25°C | @25°C | Тур. | Current | Time | Ri_{min} | R1 _{max} |
| Н | | | (Vdc) | (A) | (A) | (A) | (W) | (A) | (Sec) | (Ω) | (Ω) |
| | SMD1210-025 | αC | 30 | 100 | 0.25 | 0.50 | 0.6 | 8 | 0.02 | 0.400 | 4.500 |

Ihold = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.

Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1_{max} = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.

Environmental Specifications

| Test | Conditions | Resistance change | | | | |
|--|----------------------------|-------------------|--|--|--|--|
| Passive aging | +85°C, 1000 hrs. | ±5% typical | | | | |
| Humidity aging | +85°C, 85% R.H., 168 hours | ±5% typical | | | | |
| Thermal shock | +85°C to -40°C, 20 times | ±33% typical | | | | |
| Resistance to solvent | MIL-STD-202,Method 215 | No change | | | | |
| Vibration | MIL-STD-202,Method 201 | No change | | | | |
| Ambient operating conditions : - 40 °C to +85 °C | | | | | | |
| Maximum surface temperature of the device in the tripped state is 125 °C | | | | | | |

AGENCY APPROVALS : UL pending

Regulation/Standard: (Pb) RoHS 2002/95/EC

HF EN14582

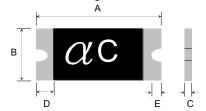
I_{hold} Versus Temperature

| noiu I | | | | | | | | | |
|-------------|-------|-------|---------------|---|------|------|------|------|------|
| Model | | | g temperature | (T _{mao}) vs. hold current (I _{hold}) | | | | | |
| Model | -40°C | -20°C | 0°C | 25°C | 40°C | 50°C | 60°C | 70°C | 85°C |
| SMD1210-025 | N 34 | 0.31 | 0.28 | 0.25 | 0.21 | 0.19 | 0.17 | 0.15 | 0.12 |

Construction And Dimension (Unit:mm)

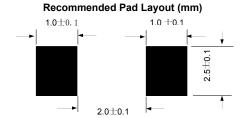
| Model | | A | | В | | | D | E |
|-------------|------|------|------|------|------|------|------|------|
| Wodel | Min. | Max. | Min. | Max. | Min. | Max. | Min. | Min. |
| SMD1210-025 | 3.00 | 3.43 | 2.35 | 2.80 | 0.30 | 0.80 | 0.30 | 0.10 |

Dimensions & Marking



α = Trademark

C = Part identification



Termination Pad Characteristics

Terminal pad materials :

Tin-plated Nickel-Copper

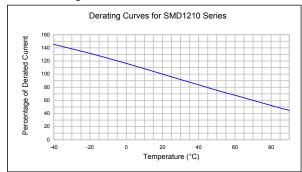
Terminal pad solderability:

Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

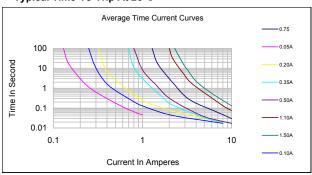
Rework

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C

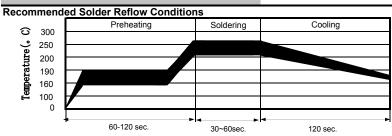


WARNING:

- $\cdot \text{ Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.}\\$
- PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

 Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
- · Use PPTC with a large inductance in circuit will generate a circuit voltage (L divid) above the rated voltag
 · Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
- · Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
- neurous.

 Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

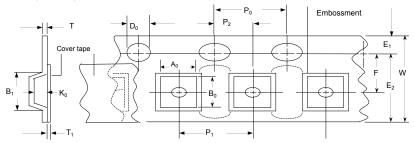


- Recommended reflow methods: IR, vapor phase oven, hot air oven.
- Devices are not designed to be wave soldered to the bottom side of the board.
- Recommended maximum paste thickness is 0.25 mm (0.010 inch).
- Devices can be cleaned using standard method and solvents.
- Note: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

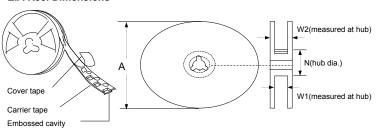
Tape And Reel Specifications (mm)

| EIA 481-2 |
|-----------------|
| 8.0 ± 0.20 |
| 4.0 ± 0.10 |
| 4.0 ± 0.10 |
| 2.0 ± 0.10 |
| 2.82 ± 0.10 |
| 3.52± 0.10 |
| 4.35 |
| 1.5 + 0.1, -0.0 |
| 7.5 ± 0.05 |
| 1.75 ± 0.10 |
| 6.25 |
| 0.6 |
| 0.1 |
| 0.90 ± 0.1 |
| 390 |
| 160 |
| |
| 178 |
| 50 |
| 8.4 + 1.5, -0.0 |
| 22.4 |
| |

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling

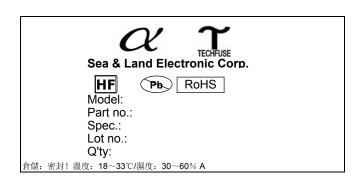
- Storage conditions: 40°C max, 70% R.H.
- Devices may not meet specified performance if storage conditions are exceeded.

Order Information Packaging

| SMD1210 | 025 | Tape & Reel Quantity |
|---------------------------|---------|----------------------|
| Product name | Hold | |
| Size 3225 mm / 1210 inch | Current | 4,500 pcs/reel |
| SMD: surface mount device | 0.25A | |

Tape & reel packaging per EIA481-1

Labeling Information



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NIS5431MT1TXG SMD250-2 0ZCM00001FF2G 0ZCM0003FF2G 0ZCM0004FF2G BK60-017-DZ-E0.6 F95456-000 LVR100S RS30-090 RS30-110 RS30-600 RS30-700 RS30-800 RS30-900 RS60RB-005 RS60RB-010 RS60RB-020 RS60RB-025 RS60RB-050 RS60RB-075 RS60RB-160 RS60SB-250 ASMD0603-010-30V ASMD0603-025-16V ASMD2920-260-24V BSMD0603-025-12V BSMD1206-150-12V BSMD0805-020-33V BSMD1206-075-13.2V BSMD2920-400-6V BSMD2920-300-6V BSMD2920-700-6V